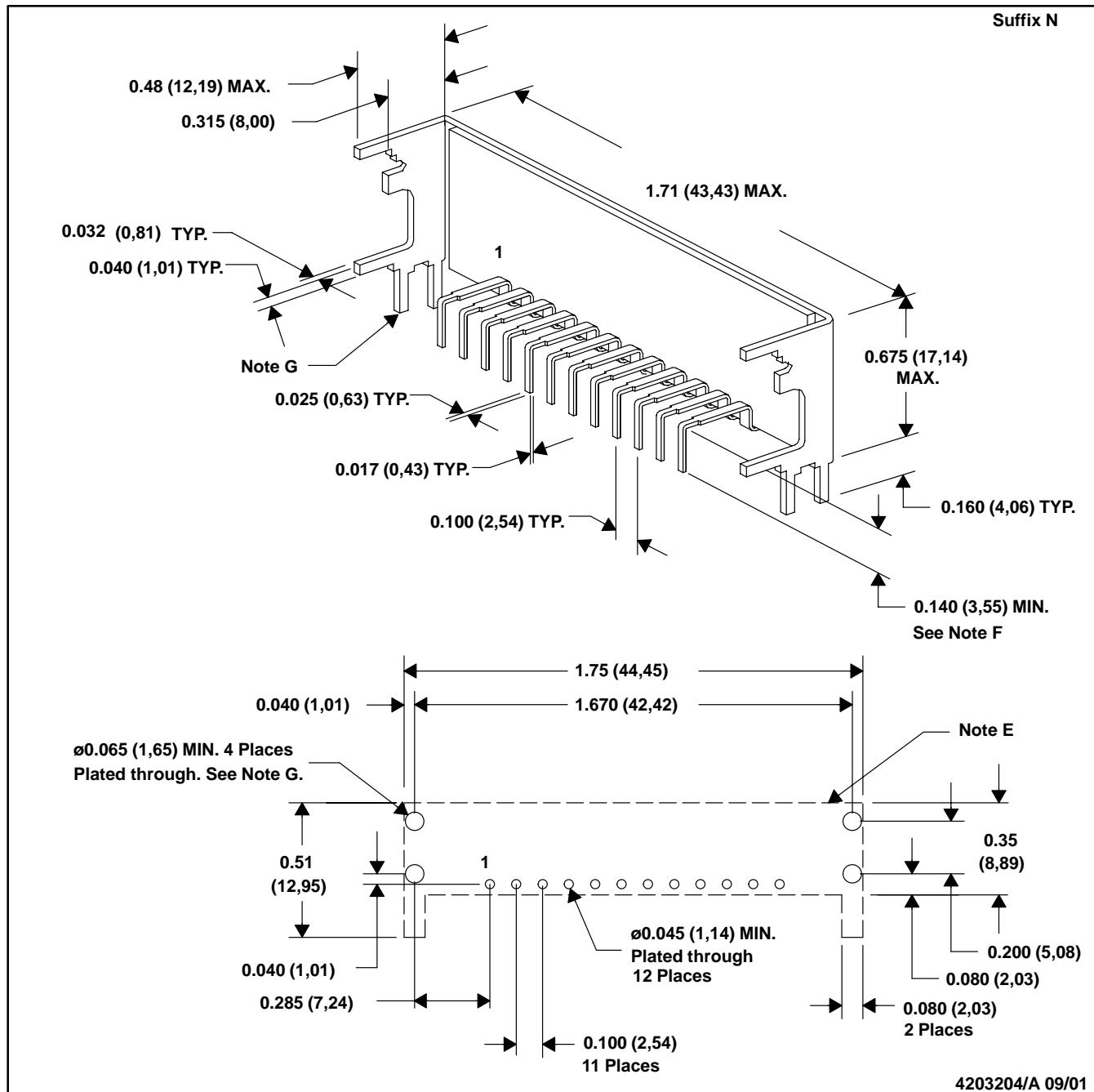


EPH (R-MSIP-T12)

METAL SINGLE-IN-LINE MODULE



NOTES: A. All linear dimensions are in inches (mm).  
 B. This drawing is subject to change without notice.  
 C. 2 place decimals are  $\pm 0.030$  ( $\pm 0.76$ mm).  
 D. 3 place decimals are  $\pm 0.010$  ( $\pm 0.25$ mm).

E. Recommended mechanical keep out area.  
 F. Electrical pin length mounted on circuit board seating plane to pin end.  
 G. Electrically connect case to ground plane.

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